



# Product Change Notification

## 106303 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 106303 - 00  
**Change Title:** Intel NetStructure® MPCHC0001 14U Chassis, PCN 106303-00, Product Design, PEM, Fan Tray, and Packaging changes  
**Date of Publication:** May 11, 2006

**Key Characteristics of the Change:**  
Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 19, 2006
-------------------------------------------------------------------------	--------------

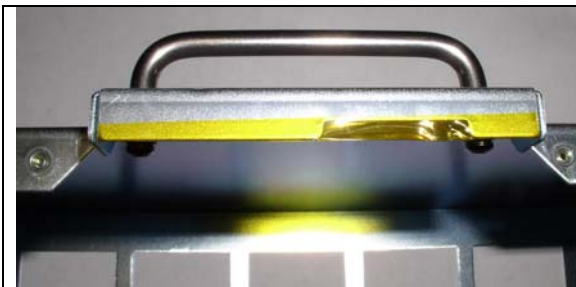
## Description of Change to the Customer:

### 1. Fan tray insulator

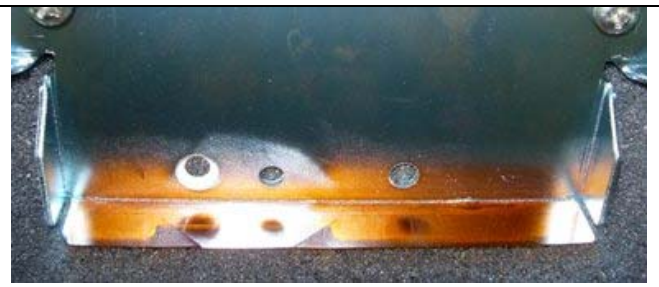
Description of change:

Adjust length of Insulator between fan tray board and top sheet metal to better fit.

Create another insulator to cover area currently being covered by Kapton tape on the front inside of the fan tray, as shown below.



Old – Kapton Tape



New – Kapton insulator

### 2. PEM Cable

Description of change: Replace PEM cable with better material making the cable more flexible for manufacturing and is a RoHS compliant cable. Part is inside of PEM, and not user servicable.

### 3. Packaging Foam modification

Description of change: Increase the cutout size on the bottom foam piece to allow a better fit for the accessory kit box..

### Customer Impact of Change and Recommended Action:

No customer impact

### Products Affected / Intel Ordering Codes:

#### System Products Table

Affected Product Code	Pre-Change MM#	Post-Change MM#	Pre-Change TA	Post-Change TA	Pre-Change Subassembly	Post-Change Subassembly
MPCHC0001	848998	848998	C94926-008	C94926-009		

### Reference Documents / Attachments:

Document:

Location #:

### PCN Revision History:

Date of Revision:

May 11, 2006

Revision Number:

00

Reason:

Originally Published PCN